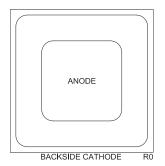


# CPD16-CMR1U-06M

## Ultra Fast Rectifier Die 1.0 Amp, 600 Volt

The CPD16-CMR1U-06M is a silicon 1.0 Amp, 600 Volt ultra fast recovery rectifier ideal for all types of commercial, industrial, entertainment, and computer applications.



### **MECHANICAL SPECIFICATIONS:**

50 x 50 MILS
12.5 MILS
34 x 34 MILS
Ni/Au - 3,000Å/1,350Å
Ni/Au – 3,000Å/1,350Å
3.0 MILS
4 INCHES
4,250

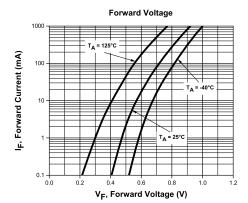
	MAXIMUM R	ATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
	Peak Repetiti	ve Reverse Voltage	$V_{RRM}$	600	V
	DC Blocking	Voltage	$V_{R}$	600	V
	RMS Reverse	e Voltage	V <sub>R</sub> (RMS)	420	V
	Average Forv	vard Current (T <sub>A</sub> =75°C)	ì <sub>o</sub>	1.0	Α
	Peak Forward	d Surge Current, tp=8.3ms	I <sub>FSM</sub>	30	Α
	Operating an	d Storage Junction Temperature	$T_J$ , $T_{stg}$	-65 to +150	°C
ELECTRICAL CHARACTERISTICS: (T <sub>A</sub> =25°C)					
	SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
	$I_{R}$	V <sub>R</sub> =600V		5.0	μΑ
	VF	I <sub>F</sub> =1.0A		1.4	V
	СЈ	V <sub>R</sub> =0, f=1.0MHz		40	pF
	t <sub>rr</sub>	I <sub>F</sub> =0.5A, I <sub>R</sub> =1.0A, I <sub>rr</sub> =0.25A		75	ns

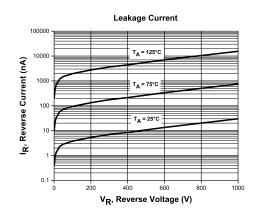
# CPD16-CMR1U-06M

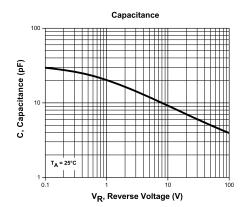
## **Typical Electrical Characteristics**

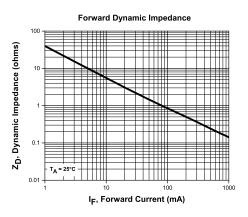


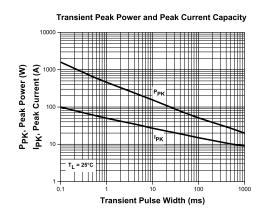
www.centralsemi.com

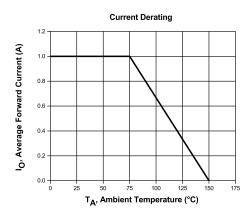








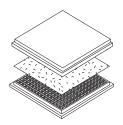




R3 (13-March 2019)

## BARE DIE PACKING OPTIONS

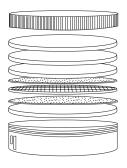




## BARE DIE IN TRAY (WAFFLE) PACK

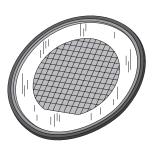
CT: Singulated die in tray (waffle) pack.
(example: CP211-PART NUMBER-CT)

CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-PART NUMBER-CM)



## **UNSAWN WAFER**

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



#### SAWN WAFER ON PLASTIC RING

**WR**: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked.

(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### **CONTACT US**

#### Corporate Headquarters & Customer Support Team

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